DECLARATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

LOW TEMPERATURE EXTRUSION PROCESS AND DEVICE FOR ENERGY OPTIMIZED AND VISCOSITY ADAPTED MICRO-STRUCTURING OF FROZEN AERATED MASSES

the sp	ecification of which: (c	check one)			
•	is attached hereto.				
X	was filed on 20 Janu International Applicat and was amended on	ion No. PCT/EP			
I here	eby state that I have ication, including the cl	reviewed and aims, as amende	understand the contents of ed by any amendment referred	the above-identified to above.	
knowr		to the patentabil	nited States Patent Office all ity of this application in account		
Section of any States, for part	n 365(b) of any foreign PCT international applisted below and have	application(s) f lication which de also identified b ficate or PCT in	der Title 35, United States for patent or inventor's certific esignated at least one country below, by checking the box, atternational application having imed.	cate, or Section 365(a) other than the United ny foreign application	
Prior F	Foreign Application(s)				
	Number	Country	Day/Month/Year Filed	Priority Not Claimed	
10 20	004 003 448.6	Germany	22 January 2004		

I hereby claim the benefit under 35 U.S.C. Section 119(e) of any United States provisional application(s) listed below:

Application Serial No.

Filing Date

I hereby claim the benefit under 35 U.S.C. Section 120 of any United States application(s), or Section 365(c) of any PCT international application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the first paragraph of 35 U.S.C. Section 112, I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, C.F.R., Section 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

Application Serial No.

Filing Date

Status (patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor

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Sole or first inventor's signature

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